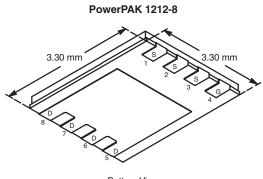


RoHS COMPLIANT

Vishay Siliconix

N-Channel 30-V (D-S) Fast Switching MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	r _{DS(on)} (Ω)	I _D (A)		
30	0.0075 at V _{GS} = 10 V	17.8		
	0.0082 at V_{GS} = 4.5 V	17.0		



Bottom View

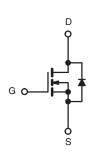
Ordering Information: Si7112DN-T1 Si7112DN-T1-E3 (Lead (Pb)-free)

FEATURES

- TrenchFET[®] Power MOSFET
- New Low Thermal Resistance PowerPAK® Package with Low 1.07 mm Profile
- 100 % R_g Tested
- Lead (Pb)-free Version is RoHS Compliant

APPLICATIONS

Synchronous Rectification



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	$T_A = 25 \ ^{\circ}C$, unles	ss otherwise r	noted			
Parameter	Symbol	10 sec	Steady State	Unit		
Drain-Source Voltage		V _{DS}	30		V	
Gate-Source Voltage		V _{GS}	± 12			
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 25 °C	- I _D	17.8	11.3		
	T _A = 70 °C		14.2	9.1		
Pulsed Drain Current		I _{DM}	60		А	
Continuous Source Current (Diode Conduction) ^a		I _S	3.2	1.3		
Single Avalanche Current	L = 0.1 mH	I _{AS} 20		20		
Single Avalanche Energy	L = 0.1 mH	E _{AS}	20		mJ	
	T _A = 25 °C	P _D	3.8	1.5	W	
Maximum Power Dissipation ^a	T _A = 70 °C		2.0	0.8		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C	
Soldering Recommendations (Peak Temperature) ^{b, c}			260			
THERMAL RESISTANCE RATINGS	\$					
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^a	t ≤ 10 sec	R _{thJA}	24	33	°C/W	
waximum junction-to-Ambient*	Steady State		65	81		
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	1.9	2.4		

Notes:

a. Surface Mounted on 1" x 1" FR4 Board. b. See Solder Profile (*http://www.vishay.com/ppg?73257*). The PowerPAK 1212-8 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection. c. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

* Pb containing terminations are not RoHS compliant, exemptions may apply.

Si7112DN

Vishay Siliconix

VISHAY	B

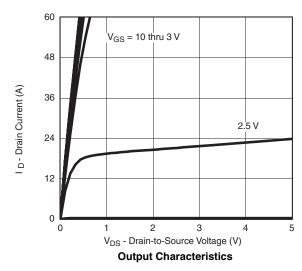
Parameter	Symbol	Symbol Test Conditions		Тур	Max	Unit
Static						
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$			1.5	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}$			1	
		V_{DS} = 30 V, V_{GS} = 0 V, T_{J} = 55 °C			5	μA
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	40			А
Drain-Source On-State Resistance ^a		V _{GS} = 10 V, I _D = 17.8 A	0.006 0.007		0.0075	0
	r _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 17 \text{ A}$		0.0065 0.0082		Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 17.8 A		97		S
Diode Forward Voltage ^a	V _{SD}	$I_{\rm S}$ = 3.2 A, $V_{\rm GS}$ = 0 V		0.7	1.2	V
Dynamic ^b			1			
Input Capacitance	C _{iss}			260		pF
Output Capacitance	C _{oss}	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		340		
Reverse Transfer Capacitance	C _{rss}			145		
Total Gate Charge	Qg			18	27	nC
Gate-Source Charge	Q _{gs}	V_{DS} = 15 V, V_{GS} = 4.5 V, I_{D} = 17.8 A		6.2		
Gate-Drain Charge	Q _{gd}			3.1		
Gate Resistance	Rg	f = 1 MHz	0.5	1.2	1.8	Ω
Turn-On Delay Time	t _{d(on)}			10	15	
Rise Time	t _r	V_{DD} = 15 V, R_L = 15 Ω		10	15	ns
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ 1 A, V_{GEN} = 10 V, R_g = 6 Ω		65	100	
Fall Time	t _f			10	15	
Body Diode Reverse Recovery Time	t _{rr}	L = 2.2 A di/dt = 100 A/		30	60	
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = 3.2 A, di/dt = 100 A/μs		18		nC

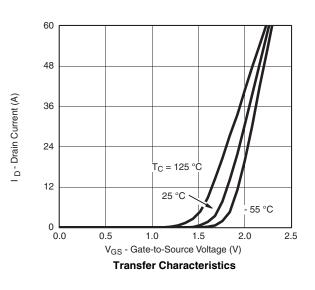
Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C unless noted





Si7112DN Vishay Siliconix Ciss

C_{rss}

25

30

20

3500

3000

2500

2000

1500

1000

500

0

0

Coss

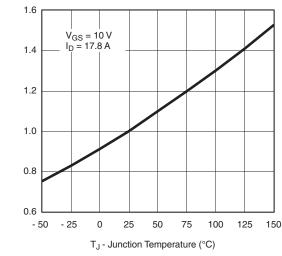
5

10

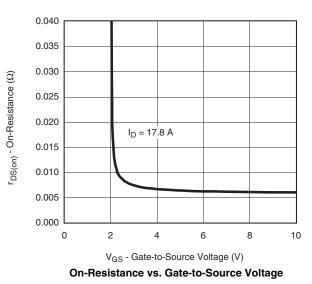
C - Capacitance (pF)

r_{DS(on)} - On-Resistance (Normalized)

15 V_{DS} - Drain-to-Source Voltage (V) Capacitance



On-Resistance vs. Junction Temperature



TYPICAL CHARACTERISTICS 25 °C unless noted

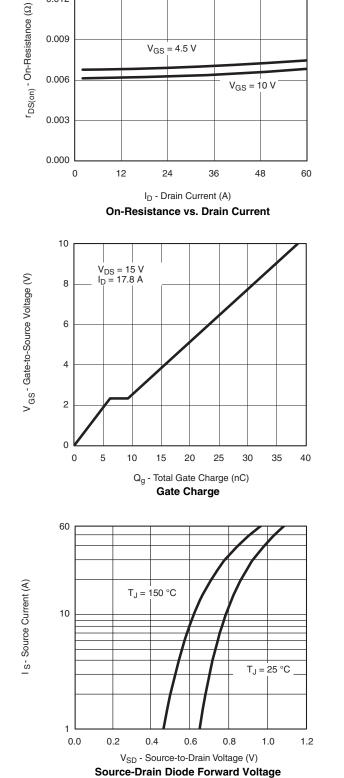
 $V_{GS} = 4.5 V$

VISHAY

0.015

0.012

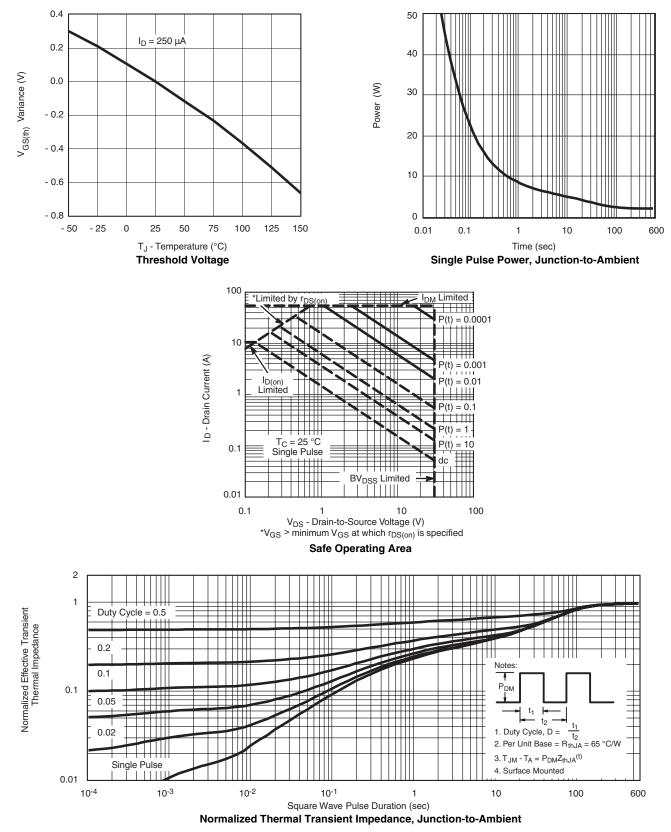
0.009



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TYPICAL CHARACTERISTICS 25 °C unless noted



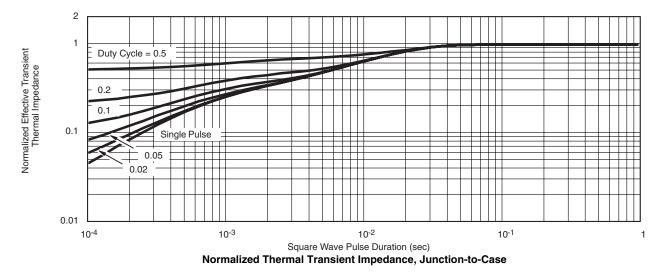
ISHA



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TYPICAL CHARACTERISTICS 25 °C unless noted



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72864.



Vishay

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